



## MS5803-14BA

### Miniature 14 bar Module

The MS5803-14BA is a new generation of high resolution pressure sensors with SPI and I2C bus interface. The MS5803-14BA HE is the High Endurance version of MS5803-14BA sensor. It is optimized for depth measurement systems with a water depth resolution of 1cm and below. The sensor module includes a high linear pressure sensor and an ultra-low power 24 bit  $\Delta\Sigma$  ADC with internal factory calibrated coefficients. It provides a precise digital 24 Bit pressure and temperature value and different operation modes that allow the user to optimize for conversion speed and current consumption. A high resolution temperature output allows the implementation of a depth measurement systems and thermometer function without any additional sensor. The MS5803-14BA can be interfaced to any microcontroller. The communication protocol is simple, without the need to programming internal registers in the device. The gel protection and antimagnetic stainless steel cap protects against 30 bar overpressure water resistant. This new sensor module generation is based on leading MEMS technology and latest benefits from the TE proven experience and know-how in high volume manufacturing of pressure modules have been widely used for over a decade. This sensing principle employed leads to very low hysteresis and high stability of both pressure and temperature signal.

### FEATURES

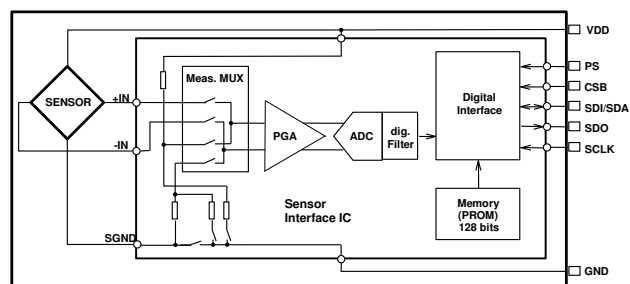
- High resolution module, 0.2mbar
- Fast conversion down to 1 ms
- Low power, 1  $\mu$ A (standby < 0.15  $\mu$ A)
- Integrated digital pressure sensor (24 bit  $\Delta\Sigma$  ADC)
- Supply voltage 1.8 to 3.6 V
- Operating range: 0 to 14bar, -40 to +85 °C
- I2C and SPI interface (Mode 0, 3)
- No external components (Internal oscillator)
- Excellent long term stability
- Hermetically sealable for outdoor devices
- High Endurance (HE version)

### APPLICATIONS

- Mobile water depth measurements systems
- Diving computers
- Adventure or multi-mode watches

**TECHNICAL DATA**

| Sensor Performances ( $V_{DD} = 3\text{ V}$ )                 |                              |       |      |         |
|---------------------------------------------------------------|------------------------------|-------|------|---------|
| Pressure                                                      | Min                          | Typ   | Max  | Unit    |
| Range                                                         | 0                            |       | 14   | bar     |
| ADC                                                           |                              | 24    |      | bit     |
| Resolution (1)                                                | 1 / 0.6 / 0.4 / 0.3 / 0.2    |       |      | mbar    |
| Accuracy 0°C to +40°C,<br>0 to 6 bar (2)                      | -20                          |       | +20  | mbar    |
| Accuracy -40°C to +85°C<br>0 to 6 bar (2)                     | -40                          |       | +40  | mbar    |
| Response time                                                 | 0.5 / 1.1 / 2.1 / 4.1 / 8.22 |       |      | ms      |
| Long term stability                                           |                              | -20   |      | mbar/yr |
| Temperature                                                   | Min                          | Typ   | Max  | Unit    |
| Range                                                         | -40                          |       | +85  | °C      |
| Resolution                                                    |                              | <0.01 |      | °C      |
| Accuracy                                                      | -0.8                         |       | +0.8 | °C      |
| Notes: (1) Oversampling Ratio: 256 / 512 / 1024 / 2048 / 4096 |                              |       |      |         |
| (2) With autozero at one pressure point                       |                              |       |      |         |

**FUNCTIONAL BLOCK DIAGRAM**


## PERFORMANCE SPECIFICATIONS

### ABSOLUTE MAXIMUM RATINGS

| Parameter                                    | Symbol           | Conditions              | Min. | Typ. | Max  | Unit |
|----------------------------------------------|------------------|-------------------------|------|------|------|------|
| Supply voltage                               | V <sub>DD</sub>  |                         | -0.3 |      | +4.0 | V    |
| Storage temperature <sup>(3)</sup>           | T <sub>S</sub>   |                         | -40  |      | +125 | °C   |
| Overpressure                                 | P <sub>max</sub> | ISO 6425 <sup>(1)</sup> |      |      | 30   | bar  |
| Maximum Soldering Temperature <sup>(2)</sup> | T <sub>max</sub> | 40 sec max              |      |      | 250  | °C   |
| ESD rating                                   |                  | Human Body Model        | -4   |      | +4   | kV   |
| Latch up                                     |                  | JEDEC standard No 78    | -100 |      | +100 | mA   |

<sup>(1)</sup> The MS5807-14BA is qualified referring to the ISO 6425 standard and can withstand an absolute pressure of 30 bar in salt water.

<sup>(2)</sup> Refer to application note 808

<sup>(3)</sup> Storage in an environment of dry and non-corrosive gases

### ELECTRICAL CHARACTERISTICS

| Parameter                             | Symbol          | Conditions                                | Min. | Typ.                             | Max  | Unit |
|---------------------------------------|-----------------|-------------------------------------------|------|----------------------------------|------|------|
| Operating Supply voltage              | V <sub>DD</sub> |                                           | 1.8  | 3.0                              | 3.6  | V    |
| Operating Temperature                 | T               |                                           | -40  | +25                              | +85  | °C   |
| Supply current<br>(1 sample per sec.) | I <sub>DD</sub> | OSR<br>4096<br>2048<br>1024<br>512<br>256 |      | 12.5<br>6.3<br>3.2<br>1.7<br>0.9 |      | μA   |
| Peak supply current                   |                 | during conversion                         |      | 1.4                              |      | mA   |
| Standby supply current                |                 | at 25°C                                   |      | 0.02                             | 0.14 | μA   |
| VDD Capacitor                         |                 | From VDD to GND                           | 100  |                                  |      | nF   |

### ANALOG DIGITAL CONVERTER (ADC)

| Parameter                      | Symbol         | Conditions                                | Min.                                 | Typ.                                 | Max                                  | Unit |
|--------------------------------|----------------|-------------------------------------------|--------------------------------------|--------------------------------------|--------------------------------------|------|
| Output Word                    |                |                                           |                                      | 24                                   |                                      | bit  |
| Conversion time <sup>(4)</sup> | t <sub>c</sub> | OSR<br>4096<br>2048<br>1024<br>512<br>256 | 7.40<br>3.72<br>1.88<br>0.95<br>0.48 | 8.22<br>4.13<br>2.08<br>1.06<br>0.54 | 9.04<br>4.54<br>2.28<br>1.17<br>0.60 | ms   |

<sup>(4)</sup> Maximum values must be used to determine waiting times in I2C communication

## PERFORMANCE SPECIFICATIONS (CONTINUED)

PRESSURE OUTPUT CHARACTERISTICS ( $V_{DD} = 3\text{ V}$ ,  $T = 25^\circ\text{C}$  UNLESS OTHERWISE NOTED)

| Parameter                                                            | Conditions                                 | Min. | Typ.  | Max  | Unit    |
|----------------------------------------------------------------------|--------------------------------------------|------|-------|------|---------|
| Operating Pressure Range                                             | $P_{\text{range}}$ Full Accuracy           | 0    |       | 14   | bar     |
| Absolute Accuracy, <sup>(1)</sup><br>Temperature range 0 ... 40 °C   | 0 ... 6 bar                                | -20  |       | +20  | mbar    |
|                                                                      | 0 ... 10 bar                               | -60  |       | +20  |         |
|                                                                      | 0 ... 14 bar                               | -150 |       | +20  |         |
| Absolute Accuracy, <sup>(1)</sup><br>Temperature range -40 ... 85 °C | 0 ... 6 bar                                | -40  |       | +40  | mbar    |
|                                                                      | 0 ... 10 bar                               | -120 |       | +80  |         |
|                                                                      | 0 ... 14 bar                               | -200 |       | +100 |         |
| Maximum error with supply voltage <sup>(3)</sup>                     | $V_{DD} = 1.8\text{ V} \dots 3.6\text{ V}$ |      | +/-20 |      | mbar    |
| Long-term stability <sup>(2)</sup>                                   |                                            |      | -20   |      | mbar/yr |
| Resolution RMS                                                       | OSR 4096                                   |      | 0.2   |      | mbar    |
|                                                                      | 2048                                       |      | 0.3   |      |         |
|                                                                      | 1024                                       |      | 0.4   |      |         |
|                                                                      | 512                                        |      | 0.6   |      |         |
|                                                                      | 256                                        |      | 1.0   |      |         |

(1) Wet/dry cycle: sensor must be dried typically once a day.

(2) The long-term stability is measured with non-soldered devices.

(3) With autozero at 3V point

TEMPERATURE OUTPUT CHARACTERISTICS ( $V_{DD} = 3\text{ V}$ ,  $T = 25^\circ\text{C}$  UNLESS OTHERWISE NOTED)

| Parameter                                        | Conditions                                 | Min. | Typ.   | Max  | Unit |
|--------------------------------------------------|--------------------------------------------|------|--------|------|------|
| Absolute Accuracy                                | 0 ... 10 bar                               | -0.8 |        | +0.8 | °C   |
|                                                  | -20...85°C                                 | -2.0 |        | +2.0 |      |
|                                                  | -40...85°C                                 | -4.0 |        | +4.0 |      |
| Maximum error with supply voltage <sup>(4)</sup> | $V_{DD} = 1.8\text{ V} \dots 3.6\text{ V}$ |      | +/-0.5 |      | °C   |
| Resolution RMS                                   | OSR 4096                                   |      | 0.002  |      | °C   |
|                                                  | 2048                                       |      | 0.003  |      |      |
|                                                  | 1024                                       |      | 0.005  |      |      |
|                                                  | 512                                        |      | 0.008  |      |      |
|                                                  | 256                                        |      | 0.012  |      |      |

(4) With autozero at 3V point

**PERFORMANCE SPECIFICATIONS (CONTINUED)****DIGITAL INPUTS (PS, CSB, DIN, SCLK, SDA, SCL)**

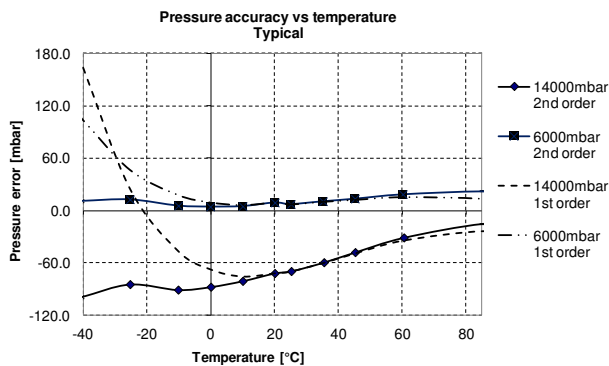
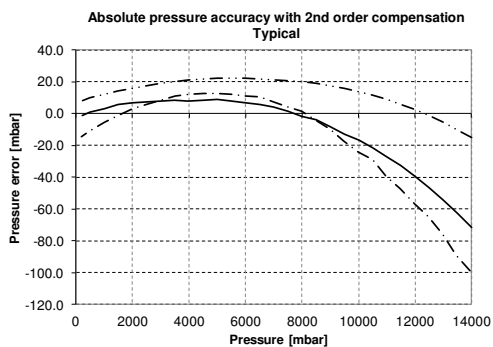
| Parameter                     | Symbol                | Conditions   | Min.                | Typ. | Max                  | Unit |
|-------------------------------|-----------------------|--------------|---------------------|------|----------------------|------|
| Serial data clock             | SCLK                  | SPI protocol |                     |      | 20                   | MHz  |
| Serial data clock             | SCL                   | I2C protocol |                     |      | 400                  | kHz  |
| Input high voltage            | V <sub>IH</sub>       | Pins CSB     | 80% V <sub>DD</sub> |      | 100% V <sub>DD</sub> | V    |
| Input low voltage             | V <sub>IL</sub>       |              | 0% V <sub>DD</sub>  |      | 20% V <sub>DD</sub>  | V    |
| Input leakage current         | I <sub>leak25°C</sub> | at 25°C      |                     |      | 0.15                 | μA   |
| CS low to first SCLK rising   | tCSL                  |              | 21                  |      |                      | ns   |
| CS low from last SCLK falling | tCSH                  |              | 21                  |      |                      | ns   |

**PRESSURE OUTPUTS (DOUT, SDA, SCL)**

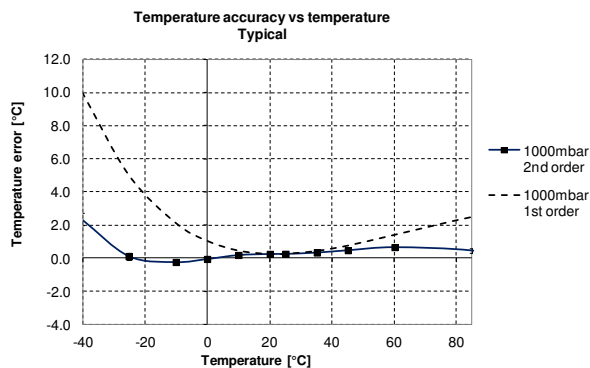
| Parameter           | Symbol            | Conditions                   | Min.                | Typ. | Max                  | Unit |
|---------------------|-------------------|------------------------------|---------------------|------|----------------------|------|
| Output high voltage | V <sub>OH</sub>   | I <sub>source</sub> = 0.6 mA | 80% V <sub>DD</sub> |      | 100% V <sub>DD</sub> | V    |
| Output low voltage  | V <sub>OL</sub>   | I <sub>sink</sub> = 0.6 mA   | 0% V <sub>DD</sub>  |      | 20% V <sub>DD</sub>  | V    |
| Load capacitance    | C <sub>LOAD</sub> |                              |                     | 16   |                      | pF   |

## PERFORMANCE CHARACTERISTICS

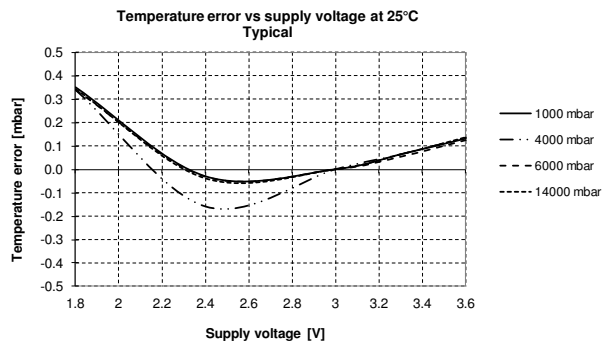
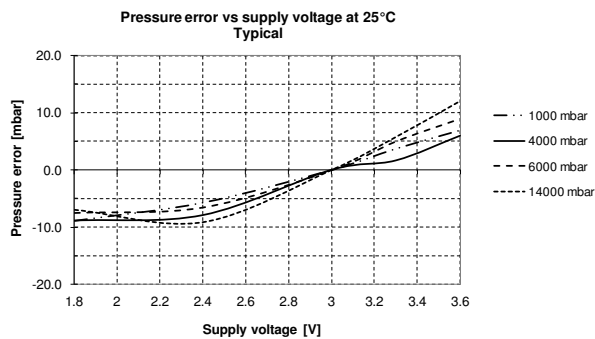
### PRESSURE ERROR VS PRESSURE AND TEMPERATURE



### TEMPERATURE ERROR VS TEMPERATURE



### PRESSURE AND TEMPERATURE ERROR VS POWER SUPPLY



## FUNCTIONAL DESCRIPTION

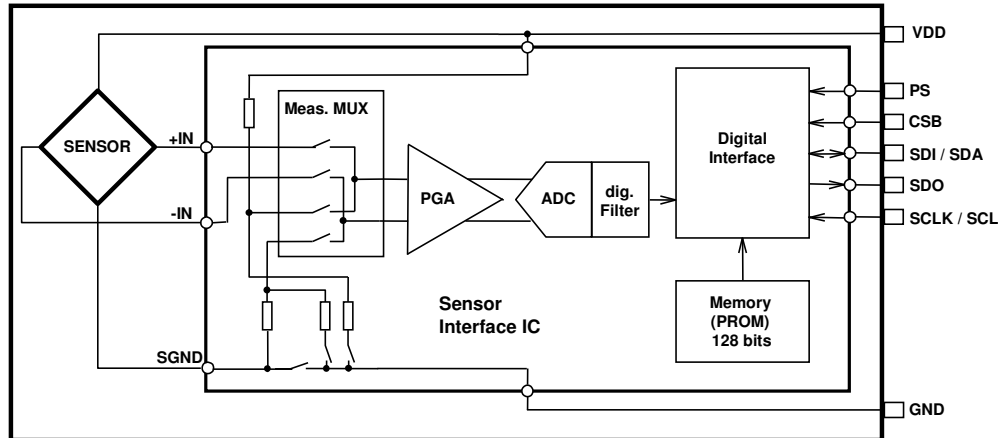


Figure 1: Block diagram of MS5803-14BA

### GENERAL

The MS5803-14BA consists of a piezo-resistive sensor and a sensor interface IC. The main function of the MS5803-14BA is to convert the uncompensated analogue output voltage from the piezo-resistive pressure sensor to a 24-bit digital value, as well as providing a 24-bit digital value for the temperature of the sensor.

### FACTORY CALIBRATION

Every module is individually factory calibrated at two temperatures and two pressures. As a result, 6 coefficients necessary to compensate for process variations and temperature variations are calculated and stored in the 128-bit PROM of each module. These bits (partitioned into 6 coefficients W1 to W6) must be read by the microcontroller software and used in the program converting D1 and D2 into compensated pressure and temperature values. The 2 coefficients W0 and W7 are for factory configuration and CRC.

### SERIAL INTERFACE

The MS5803-14BA has built in two types of serial interfaces: SPI and I<sup>2</sup>C. Pulling the Protocol Select pin PS to low selects the SPI protocol, pulling PS to high activates the I<sup>2</sup>C bus protocol.

| Pin PS | Mode             | Pins used           |
|--------|------------------|---------------------|
| High   | I <sup>2</sup> C | SDA, SCL, CSB       |
| Low    | SPI              | SDI, SDO, SCLK, CSB |

### SPI MODE

The external microcontroller clocks in the data through the input SCLK (Serial CLock) and SDI (Serial Data In). In the SPI mode module can accept both mode 0 and mode 3 for the clock polarity and phase. The sensor responds on the output SDO (Serial Data Out). The pin CSB (Chip Select) is used to enable/disable the interface, so that other devices can talk on the same SPI bus. The CSB pin can be pulled high after the command is sent or after the end of the command execution (for example end of conversion). The best noise performance from the module is obtained when the SPI bus is quiet and without communication to other devices during the ADC conversion in progress.

## I<sup>2</sup>C MODE

The external microcontroller clocks in the data through the input SCLK (Serial CLock) and SDA (Serial Data). The sensor responds on the same pin SDA which is bidirectional for the I<sup>2</sup>C bus interface. So this interface type uses only 2 signal lines and does not require a chip select, which can be favorable to reduce board space. In I<sup>2</sup>C-Mode the complement of the pin CSB (Chip Select) represents the LSB of the I<sup>2</sup>C address. It is possible to use two sensors with two different addresses on the I<sup>2</sup>C bus. The pin CSB shall be connected to VDD or GND (do not leave unconnected!).

| Pin CSB | Address (7 bits) |
|---------|------------------|
| High    | 0x76 (1110110 b) |
| Low     | 0x77 (1110111 b) |

## COMMANDS

The MS5803-14BA has only five basic commands:

1. Reset
2. Read PROM (128 bit of calibration words)
3. D1 conversion
4. D2 conversion
5. Read ADC result (24 bit pressure / temperature)

Size of each command is 1 byte (8 bits) as described in the table below. After ADC read commands the device will return 24 bit result and after the PROM read 16bit result. The address of the PROM is embedded inside of the PROM read command using the a2, a1 and a0 bits.

|                       | Command byte |     |   |     |             |             |             |      | hex value       |
|-----------------------|--------------|-----|---|-----|-------------|-------------|-------------|------|-----------------|
| Bit number            | 0            | 1   | 2 | 3   | 4           | 5           | 6           | 7    |                 |
| Bit name              | PR<br>M      | COV | - | Typ | Ad2/<br>Os2 | Ad1/<br>Os1 | Ad0/<br>Os0 | Stop |                 |
| Command               |              |     |   |     |             |             |             |      |                 |
| Reset                 | 0            | 0   | 0 | 1   | 1           | 1           | 1           | 0    | 0x1E            |
| Convert D1 (OSR=256)  | 0            | 1   | 0 | 0   | 0           | 0           | 0           | 0    | 0x40            |
| Convert D1 (OSR=512)  | 0            | 1   | 0 | 0   | 0           | 0           | 1           | 0    | 0x42            |
| Convert D1 (OSR=1024) | 0            | 1   | 0 | 0   | 0           | 1           | 0           | 0    | 0x44            |
| Convert D1 (OSR=2048) | 0            | 1   | 0 | 0   | 0           | 1           | 1           | 0    | 0x46            |
| Convert D1 (OSR=4096) | 0            | 1   | 0 | 0   | 1           | 0           | 0           | 0    | 0x48            |
| Convert D2 (OSR=256)  | 0            | 1   | 0 | 1   | 0           | 0           | 0           | 0    | 0x50            |
| Convert D2 (OSR=512)  | 0            | 1   | 0 | 1   | 0           | 0           | 1           | 0    | 0x52            |
| Convert D2 (OSR=1024) | 0            | 1   | 0 | 1   | 0           | 1           | 0           | 0    | 0x54            |
| Convert D2 (OSR=2048) | 0            | 1   | 0 | 1   | 0           | 1           | 1           | 0    | 0x56            |
| Convert D2 (OSR=4096) | 0            | 1   | 0 | 1   | 1           | 0           | 0           | 0    | 0x58            |
| ADC Read              | 0            | 0   | 0 | 0   | 0           | 0           | 0           | 0    | 0x00            |
| PROM Read             | 1            | 0   | 1 | 0   | Ad2         | Ad1         | Ad0         | 0    | 0xA0 to<br>0xAE |

Figure 2: Command structure



## I<sup>2</sup>C INTERFACE

### COMMANDS

Each I<sup>2</sup>C communication message starts with the start condition and it is ended with the stop condition. The MS5803-14BA address is 111011Cx, where C is the complementary value of the pin CSB. Since the IC does not have a microcontroller inside, the commands for I<sup>2</sup>C and SPI are quite similar.

### RESET SEQUENCE

The reset can be sent at any time. In the event that there is not a successful power on reset this may be caused by the SDA being blocked by the module in the acknowledge state. The only way to get the MS5803-14BA to function is to send several SCLKs followed by a reset sequence or to repeat power on reset.

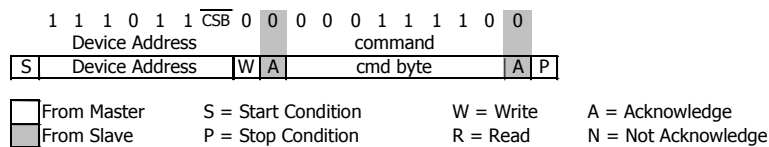


Figure 3: I<sup>2</sup>C Reset Command

### CONVERSION SEQUENCE

A conversion can be started by sending the command to MS5803-14BA. When command is sent to the system it stays busy until conversion is done. When conversion is finished, the data can be accessed by sending a Read command, when an acknowledge appears from the MS5803-14BA, 24 SCLK cycles may be sent to receive all result bits. Every 8 bit the system waits for an acknowledge signal.

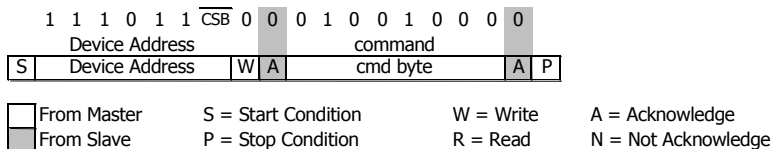


Figure 4: I<sup>2</sup>C Command to initiate a pressure conversion (OSR=4096, typ=D1)

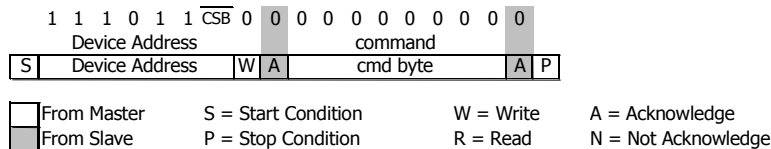


Figure 5: I<sup>2</sup>C ADC read sequence

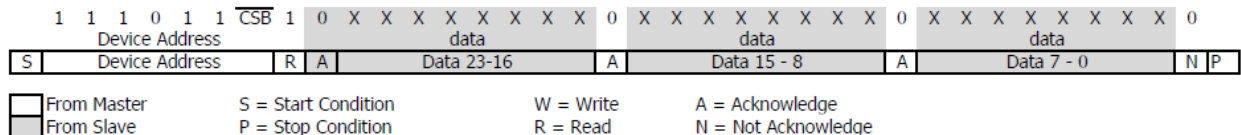


Figure 6: I<sup>2</sup>C pressure response (D1) on 24 bit from MS5803-14BA

## PROM READ SEQUENCE

The PROM Read command consists of two parts. First command sets up the system into PROM read mode. The second part gets the data from the system.

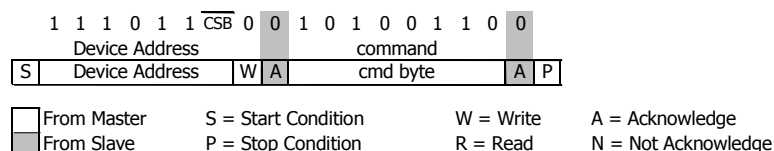


Figure 7: I<sup>2</sup>C Command to read memory address= 011 (Coefficient 3)

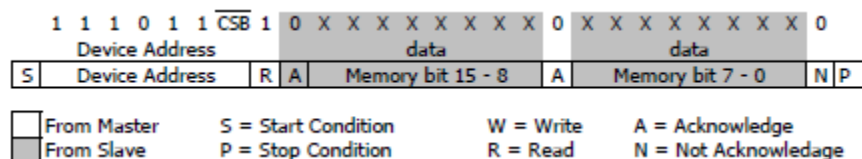


Figure 8: I<sup>2</sup>C answer from MS5803-14BA

## SPI INTERFACE

### RESET SEQUENCE

The Reset sequence shall be sent once after power-on to make sure that the calibration PROM gets loaded into the internal register. It can be also used to reset the device ROM from an unknown condition

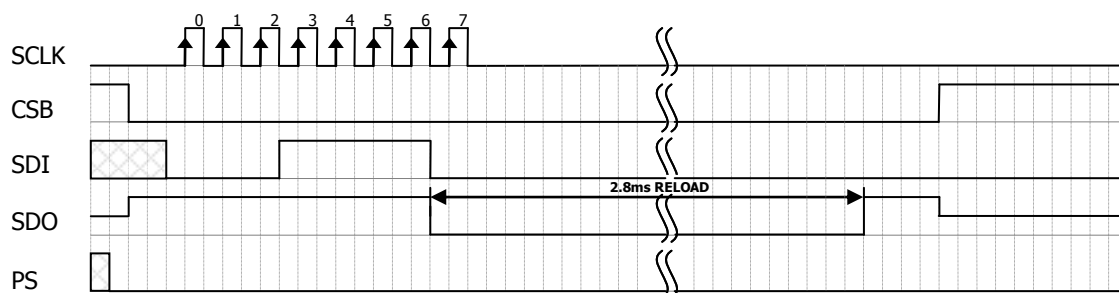


Figure 9: Reset command sequence SPI mode 0

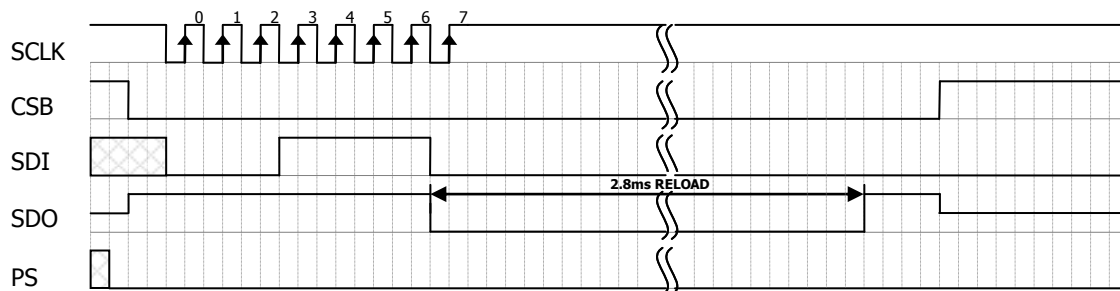
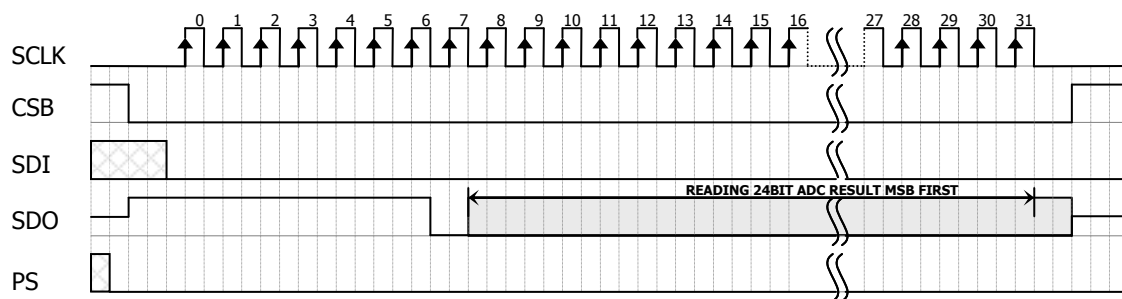
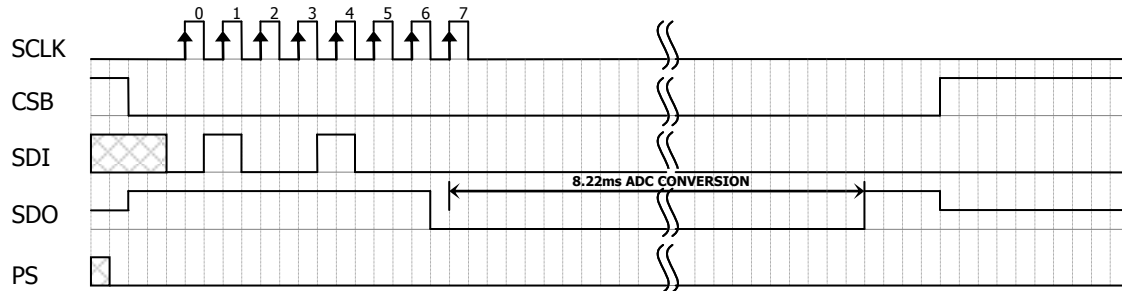


Figure 10: Reset command sequence SPI mode 3

## CONVERSION SEQUENCE

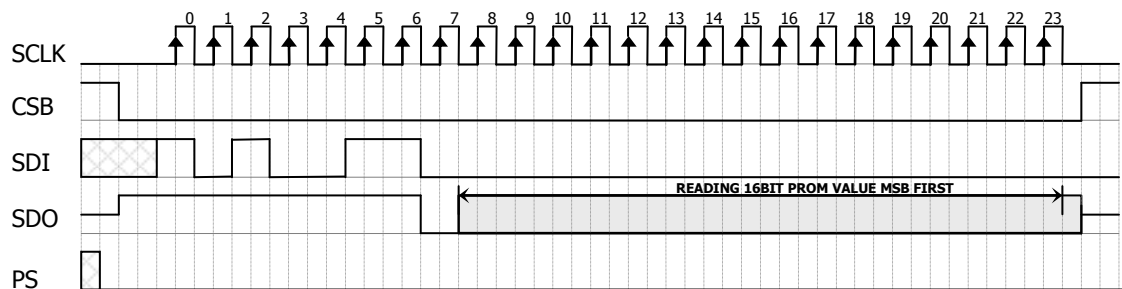
The conversion command is used to initiate uncompensated pressure (D1) or uncompensated temperature (D2) conversion. The chip select can be disabled during this time to communicate with other devices.

After the conversion, using ADC read command the result is clocked out with the MSB first. If the conversion is not executed before the ADC read command, or the ADC read command is repeated, it will give 0 as the output result. If the ADC read command is sent during conversion the result will be 0, the conversion will not stop and the final result will be wrong. Conversion sequence sent during the already started conversion process will yield incorrect result as well.



## PROM READ SEQUENCE

The read command for PROM shall be executed once after reset by the user to read the content of the calibration PROM and to calculate the calibration coefficients. There are in total 8 addresses resulting in a total memory of 128 bit. Address 0 contains factory data and the setup, addresses 1-6 calibration coefficients and address 7 contains the serial code and CRC. The command sequence is 8 bits long with a 16 bit result which is clocked with the MSB first.



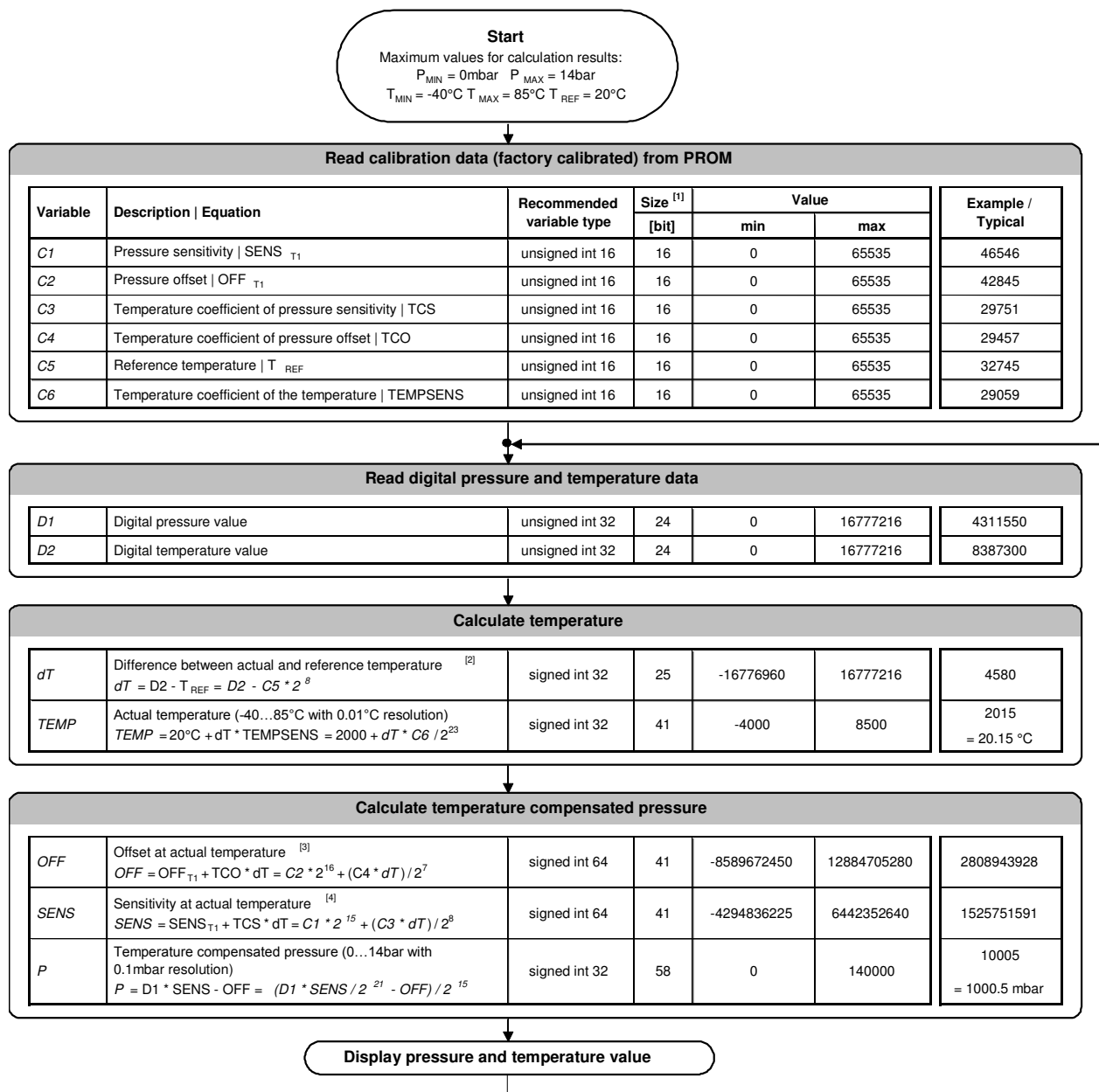
CYCLIC REDUNDANCY CHECK (CRC)

MS5803-14BA contains a PROM memory with 128-Bit. A 4-bit CRC has been implemented to check the data validity in memory. The application note AN520 describes in detail CRC-4 code used.

|   |                                  |   |   |   |   |   |   |   |   |   |   |   |   |   |   |     |
|---|----------------------------------|---|---|---|---|---|---|---|---|---|---|---|---|---|---|-----|
| A | D                                | D | D | D | D | D | D | D | D | D | D | D | D | D | D | D   |
| d | B                                | B | B | B | B | B | B | B | B | B | B | B | B | B | B | B   |
| d | 5                                | 4 | 3 | 2 | 1 | 0 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0   |
| 0 | 16 bit reserved for manufacturer |   |   |   |   |   |   |   |   |   |   |   |   |   |   |     |
| 1 | Coefficient 1 (16 bit unsigned)  |   |   |   |   |   |   |   |   |   |   |   |   |   |   |     |
| 2 | Coefficient 2 (16 bit unsigned)  |   |   |   |   |   |   |   |   |   |   |   |   |   |   |     |
| 3 | Coefficient 3 (16 bit unsigned)  |   |   |   |   |   |   |   |   |   |   |   |   |   |   |     |
| 4 | Coefficient 4 (16 bit unsigned)  |   |   |   |   |   |   |   |   |   |   |   |   |   |   |     |
| 5 | Coefficient 5 (16 bit unsigned)  |   |   |   |   |   |   |   |   |   |   |   |   |   |   |     |
| 6 | Coefficient 6 (16 bit unsigned)  |   |   |   |   |   |   |   |   |   |   |   |   |   |   |     |
| 7 |                                  |   |   |   |   |   |   |   |   |   |   |   |   |   |   | CRC |

Figure 14: Memory PROM mapping

## PRESSURE AND TEMPERATURE CALCULATION



**Notes**

- [1] Maximal size of intermediate result during evaluation of variable  
 [2] min and max have to be defined  
 [3] min and max have to be defined  
 [4] min and max have to be defined

Figure 15: Flow chart for pressure and temperature reading and software compensation.

## SECOND ORDER TEMPERATURE COMPENSATION

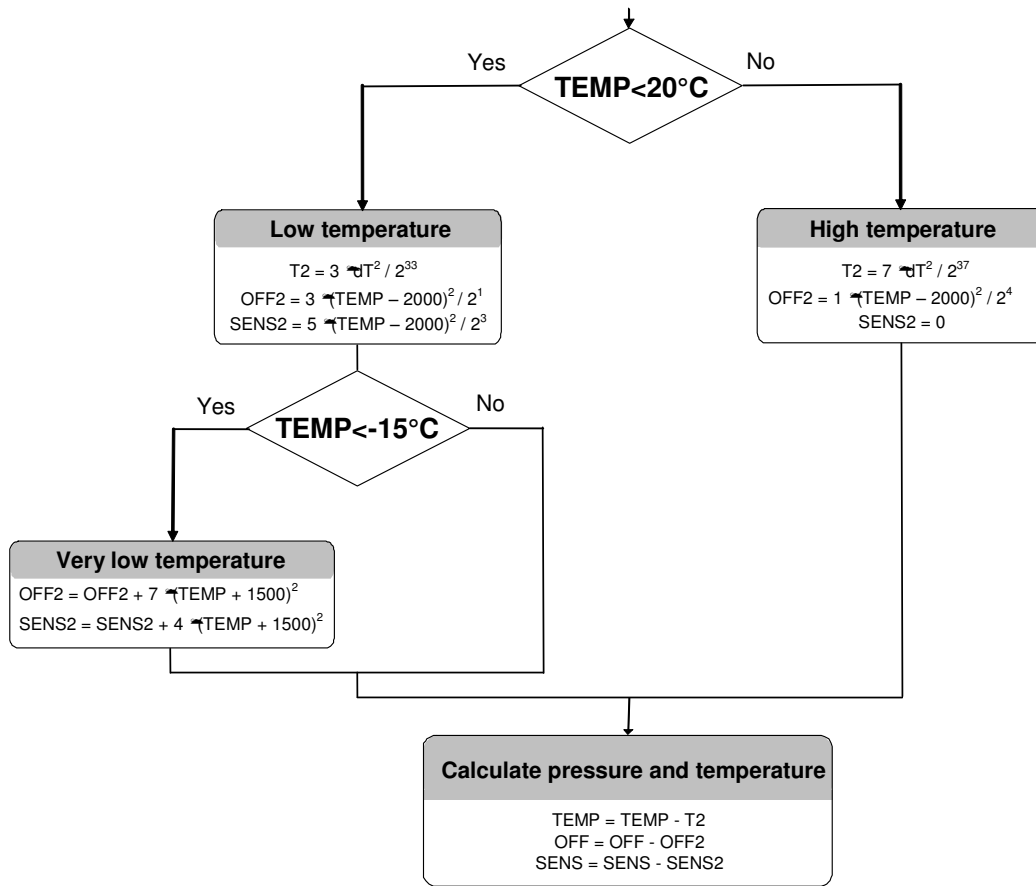
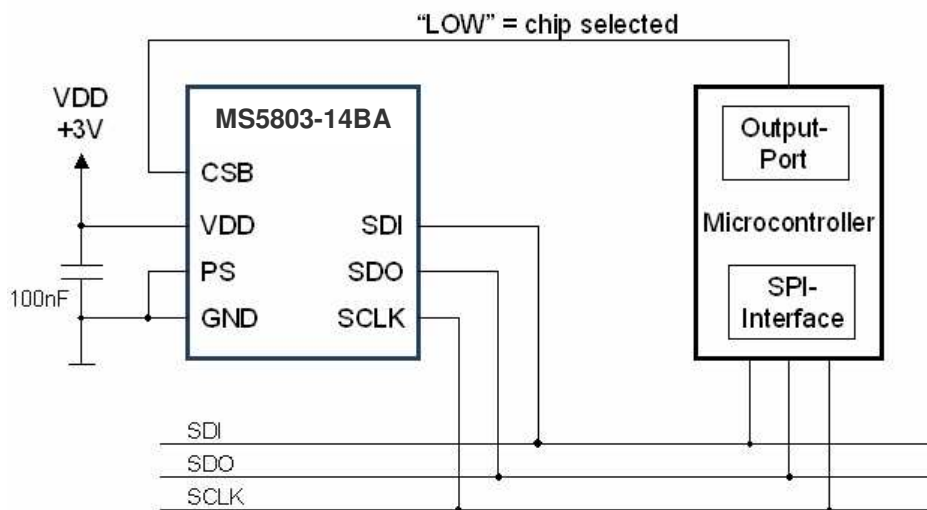


Figure 16: Flow chart for pressure and temperature to the optimum accuracy.

## APPLICATION CIRCUIT

The MS5803-14BA is a circuit that can be used in conjunction with a microcontroller in mobile depth-meter applications. It is designed for low-voltage systems with a supply voltage of 3 V.

### SPI protocol communication



### I<sup>2</sup>C protocol communication

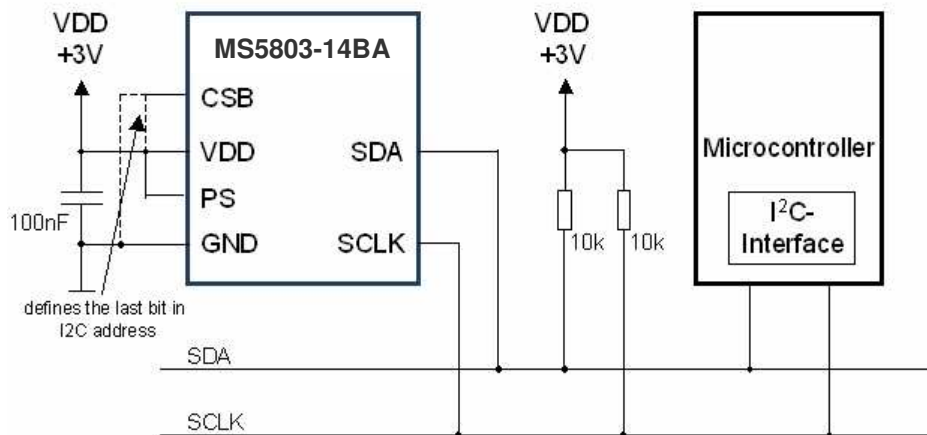


Figure 17: Typical application circuit with SPI / I<sup>2</sup>C protocol communication

## PACKAGE OUTLINE AND PIN CONFIGURATION

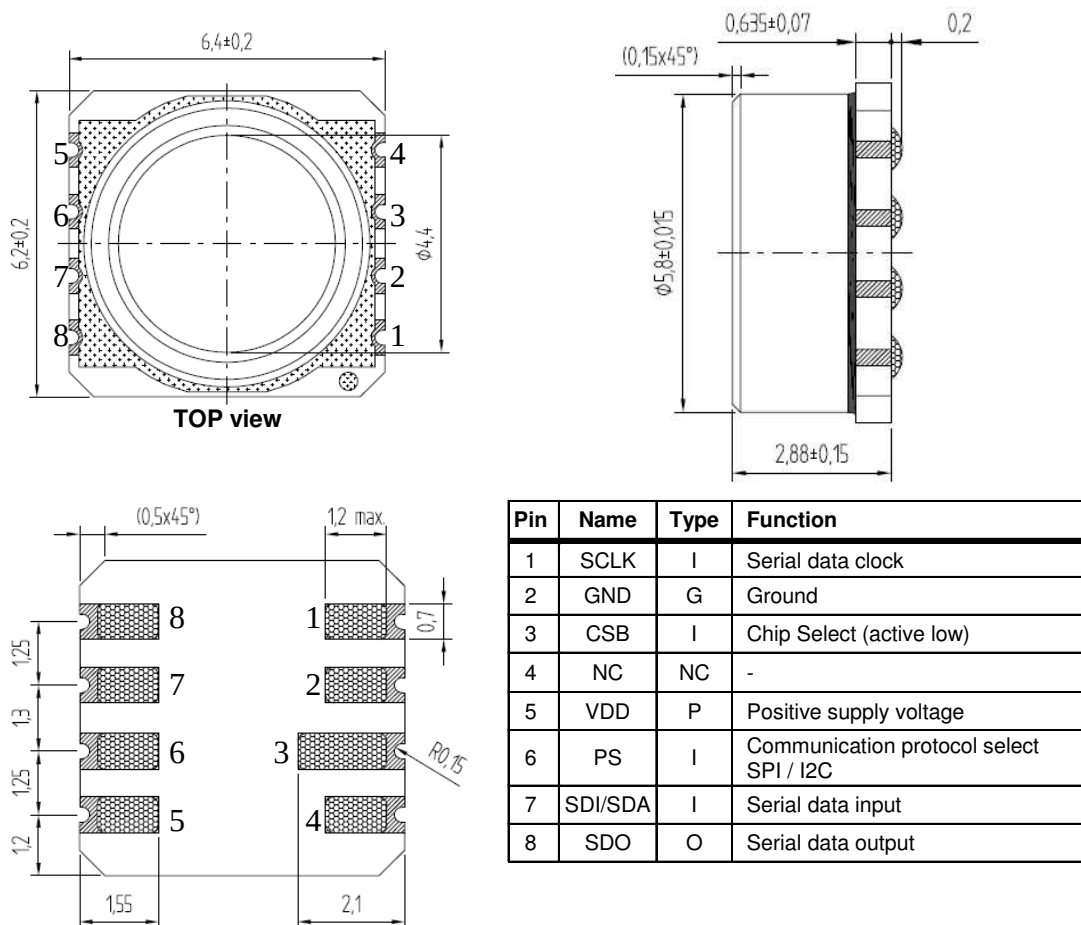
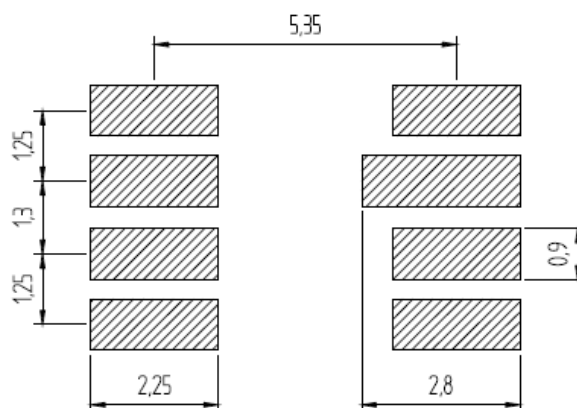


Figure 18: MS5803-14BA package outlines, pin configuration and description

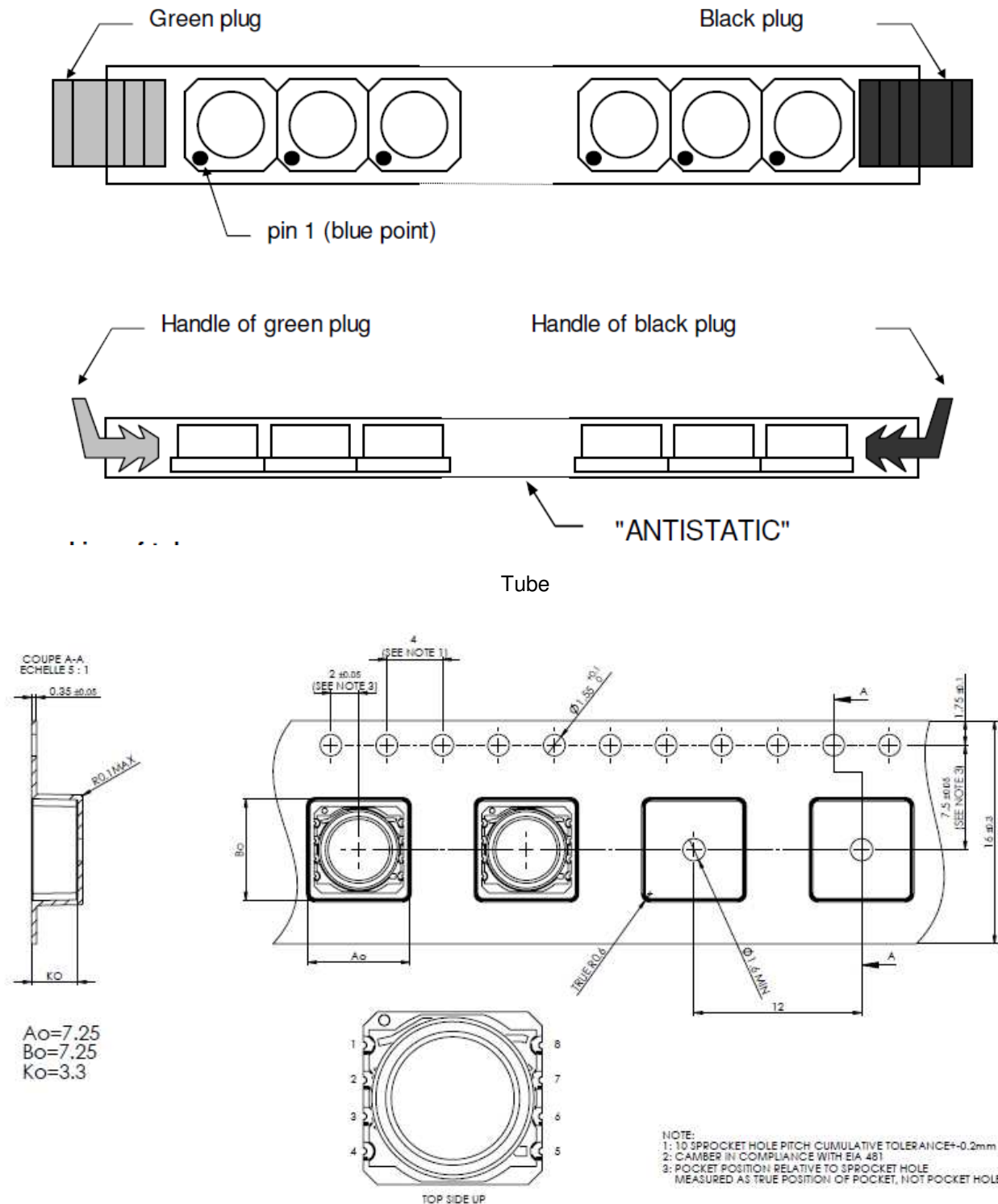
- Notes:**
- (1) Dimensions in mm
  - (2) General tolerance  $\pm 0,1$
  - (3) Cap centering  $\pm 0,15$  from center of the ceramic

## RECOMMENDED PAD LAYOUT





## SHIPPING PACKAGE



Tape & reel

## MOUNTING AND ASSEMBLY CONSIDERATIONS

### SOLDERING

Please refer to the application note AN808 available on our website for all soldering issues.

### MOUNTING

The MS5803-14BA can be placed with automatic Pick & Place equipment using vacuum nozzles. It will not be damaged by the vacuum. Due to the low stress assembly the sensor does not show pressure hysteresis effects. It is important to solder all contact pads.

### CONNECTION TO PCB

The package outline of the module allows the use of a flexible PCB for interconnection. This can be important for applications in watches and other special devices.

### SEALING WITH O-RINGS

In products like outdoor watches the electronics must be protected against direct water or humidity. For those products the MS5803-14BA provides the possibility to seal with an O-ring. The protective cap of the MS5803-14BA is made of special anticorrosive stainless steel with a polished surface. In addition to this the MS5803-14BA is filled with silicone gel covering the sensor and the bonding wires. The O-ring (or O-rings) shall be placed at the outer diameter of the metal cap. This method avoids mechanical stress because the sensor can move in vertical direction.

### CLEANING

The MS5803-14BA has been manufactured under cleanroom conditions. It is therefore recommended to assemble the sensor under class 10'000 or better conditions. Should this not be possible, it is recommended to protect the sensor opening during assembly from entering particles and dust. To avoid cleaning of the PCB, solder paste of type "no-clean" shall be used. Cleaning might damage the sensor!

### ESD PRECAUTIONS

The electrical contact pads are protected against ESD up to 4 kV HBM (human body model). It is therefore essential to ground machines and personnel properly during assembly and handling of the device. The MS5803-14BA is shipped in antistatic transport boxes. Any test adapters or production transport boxes used during the assembly of the sensor shall be of an equivalent antistatic material.

### DECOUPLING CAPACITOR

Particular care must be taken when connecting the device to the power supply. A 100 nF ceramic capacitor must be placed as close as possible to the MS5803-14BA VDD pin. This capacitor will stabilize the power supply during data conversion and thus, provide the highest possible accuracy.

## ORDERING INFORMATION

| PART NUMBER     | DESCRIPTION                        | Delivery Form      |
|-----------------|------------------------------------|--------------------|
| MS580314BA01-00 | MS5803-14BA 14BAR White Gel        | Tube               |
| MS580314BA01-50 | MS5803-14BA 14BAR White Gel T&R    | Tape & Reel TOP-UP |
| MS580314BA06-50 | MS5803-14BA 14BAR White Gel HE T&R | Tape & Reel TOP-UP |

### PRODUCT DESCRIPTION

MS5803\_\_BA\_\_

#### Pressure Range

|    |        |
|----|--------|
| 14 | 14 bar |
|----|--------|

#### Version

|    |                |
|----|----------------|
| 01 | Standard       |
| 06 | High Endurance |

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